

Irish Standard I.S. EN IEC 60352-5:2020

Solderless connections - Part 5: Press-in connections - General requirements, test methods and practical guidance

 $\ensuremath{\mathbb{C}}$  CENELEC 2020  $\hfill No copying without NSAI permission except as permitted by copyright law.$ 

### I.S. EN IEC 60352-5:2020

Incorporating amendments/corrigenda/National Annexes issued since publication:

The National Standards Authority of Ireland (NSAI) produces the following categories of formal documents:

I.S. xxx: Irish Standard – national specification based on the consensus of an expert panel and subject to public consultation.

S.R. xxx: Standard Recommendation – recommendation based on the consensus of an expert panel and subject to public consultation.

SWiFT xxx: A rapidly developed recommendatory document based on the consensus of the participants of an NSAI workshop.

This document replaces/revises/consolidates the NSAI adoption of the document(s) indicated on the CEN/CENELEC cover/Foreword and the following National document(s):

*NOTE: The date of any NSAI previous adoption may not match the date of its original CEN/CENELEC document.* 

This document is based on: EN IEC 60352-5:2020 *Published:* 2020-09-11

This document was published under the authority of the NSAI and comes into effect on:

2020-09-28

ICS number:

31.220.10

NOTE: If blank see CEN/CENELEC cover page

NSAI	T +353 1 807 3800	Sales:
1 Swift Square,	F +353 1 807 3838	T +353 1 857 6730
Northwood, Santry	E standards@nsai.ie	F +353 1 857 6729
Dublin 9	W NSAI.ie	W standards.ie

Údarás um Chaighdeáin Náisiúnta na hÉireann

## **National Foreword**

I.S. EN IEC 60352-5:2020 is the adopted Irish version of the European Document EN IEC 60352-5:2020, Solderless connections - Part 5: Press-in connections - General requirements, test methods and practical guidance

This document does not purport to include all the necessary provisions of a contract. Users are responsible for its correct application.

For relationships with other publications refer to the NSAI web store.

### Compliance with this document does not of itself confer immunity from legal obligations.

*In line with international standards practice the decimal point is shown as a comma (,) throughout this document.* 

This is a free page sample. Access the full version online.

This page is intentionally left blank

# EUROPEAN STANDARD

# EN IEC 60352-5

NORME EUROPÉENNE

# EUROPÄISCHE NORM

September 2020

ICS 31.220.10

Supersedes EN 60352-5:2012 and all of its amendments and corrigenda (if any)

**English Version** 

# Solderless connections - Part 5: Press-in connections - General requirements, test methods and practical guidance (IEC 60352-5:2020)

Connexions sans soudure - Partie 5: Connexions insérées à force - Exigences générales, méthodes d'essai et guide pratique (IEC 60352-5:2020) Lötfreie Verbindungen - Teil 5: Einpressverbindungen -Allgemeine Anforderungen, Prüfverfahren und Anwendungshinweise (IEC 60352-5:2020)

This European Standard was approved by CENELEC on 2020-08-26. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the CEN-CENELEC Management Centre or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the CEN-CENELEC Management Centre has the same status as the official versions.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Bulgaria, Croatia, Cyprus, the Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, the Netherlands, Norway, Poland, Portugal, Republic of North Macedonia, Romania, Serbia, Slovakia, Slovenia, Spain, Sweden, Switzerland, Turkey and the United Kingdom.



European Committee for Electrotechnical Standardization Comité Européen de Normalisation Electrotechnique Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

# European foreword

The text of document 48B/2810/FDIS, future edition 5 of IEC 60352-5, prepared by SC 48B "Electrical connectors" of IEC/TC 48 "Electrical connectors and mechanical structures for electrical and electronic equipment" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 60352-5:2020.

The following dates are fixed:

- latest date by which the document has to be implemented at national (dop) 2021-05-26 level by publication of an identical national standard or by endorsement
- latest date by which the national standards conflicting with the (dow) 2023-08-26 document have to be withdrawn

This document supersedes EN 60352-5:2012 and all of its amendments and corrigenda (if any).

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CENELEC shall not be held responsible for identifying any or all such patent rights.

# Endorsement notice

The text of the International Standard IEC 60352-5:2020 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standards indicated:

IEC 60352-1	NOTE	Harmonized as EN 60352-1
IEC 61249 (series)	NOTE	Harmonized as EN 61249 (series)
IEC 61249-2-4	NOTE	Harmonized as EN 61249-2-4

# Annex ZA (normative)

# Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: <u>www.cenelec.eu</u>.

Publication	Year	Title	<u>EN/HD</u>	Year
IEC 60068-1	-	Environmental testing - Part 1: General and guidance	EN 60068-1	-
IEC 60512-1	-	Connectors for electrical and electronic equipment - Tests and measurements - Part 1: Generic specification	EN IEC 60512-1	-
IEC 60512-1-1	-	Connectors for electronic equipment - Tests and measurements - Part 1-1: General examination - Test 1a: Visual examination	EN 60512-1-1	-
IEC 60512-1-2	-	Connectors for electronic equipment - Tests and measurements - Part 1-2: General examination - Test 1b: Examination of dimension and mass	EN 60512-1-2	-
IEC 60512-2-1	-	Connectors for electronic equipment - Tests and measurements - Part 2-1: Electrical continuity and contact resistance tests - Test 2a: Contact resistance - Millivolt level method	EN 60512-2-1	-
IEC 60512-2-5	-	Connectors for electronic equipment - Tests and measurements - Part 2-5: Electrical continuity and contact resistance tests - Test 2e: Contact disturbance	EN 60512-2-5	-
IEC 60512-6-4	-	Connectors for electronic equipment - Tests and measurements - Part 6-4: Dynamic stress tests - Test 6d: Vibration (sinusoidal)	EN 60512-6-4	-
IEC 60512-11-1	-	Connectors for electrical and electronic equipment - Tests and measurements - Part 11-1: Climatic tests - Test 11a - Climatic sequence	EN IEC 60512-11-1	-
IEC 60512-11-4	-	Connectors for electronic equipment - Tests and measurements - Part 11-4: Climatic tests - Test 11d: Rapid change of temperature	EN 60512-11-4	-

# This is a free page sample. Access the full version online. $I.S.\ EN\ IEC\ 60352-5:2020$

# EN IEC 60352-5:2020 (E)

Publication	Year	Title	<u>EN/HD</u>	<u>Year</u>
IEC 60512-11-9	-	Connectors for electronic equipment - Tests and measurements - Part 11-9: Climatic tests - Test 11i: Dry heat	EN 60512-11-9	-
IEC 61188-5-1	-	Printed boards and printed board assemblies - Design and use - Part 5-1: Attachment (land/joint) considerations - Generic requirements	EN 61188-5-1	-
IEC 62326-4	-	Printed boards - Part 4: Rigid multilayer printed boards with interlayer connections - Sectional specification	EN 62326-4	-



# IEC 60352-5

Edition 5.0 2020-07

# INTERNATIONAL STANDARD

Solderless connections – Part 5: Press-in connections – General requirements, test methods and practical guidance





## THIS PUBLICATION IS COPYRIGHT PROTECTED Copyright © 2020 IEC, Geneva, Switzerland

All rights reserved. Unless otherwise specified, no part of this publication may be reproduced or utilized in any form or by any means, electronic or mechanical, including photocopying and microfilm, without permission in writing from either IEC or IEC's member National Committee in the country of the requester. If you have any questions about IEC copyright or have an enquiry about obtaining additional rights to this publication, please contact the address below or your local IEC member National Committee for further information.

**IEC Central Office** 3, rue de Varembé CH-1211 Geneva 20 Switzerland

Tel.: +41 22 919 02 11 info@iec.ch www.iec.ch

### About the IEC

The International Electrotechnical Commission (IEC) is the leading global organization that prepares and publishes International Standards for all electrical, electronic and related technologies.

### About IEC publications

The technical content of IEC publications is kept under constant review by the IEC. Please make sure that you have the latest edition, a corrigendum or an amendment might have been published.

### IEC publications search - webstore.iec.ch/advsearchform

The advanced search enables to find IEC publications by a variety of criteria (reference number, text, technical committee,...). It also gives information on projects, replaced and withdrawn publications.

IEC Just Published - webstore.iec.ch/justpublished Stay up to date on all new IEC publications. Just Published details all new publications released. Available online and once a month by email.

### IEC Customer Service Centre - webstore.iec.ch/csc

If you wish to give us your feedback on this publication or need further assistance, please contact the Customer Service Centre: sales@iec.ch.

### Electropedia - www.electropedia.org

The world's leading online dictionary on electrotechnology, containing more than 22 000 terminological entries in English and French, with equivalent terms in 16 additional languages. Also known as the International Electrotechnical Vocabulary (IEV) online.

### IEC Glossary - std.iec.ch/glossary

67 000 electrotechnical terminology entries in English and French extracted from the Terms and Definitions clause of IEC publications issued since 2002. Some entries have been collected from earlier publications of IEC TC 37, 77, 86 and CISPR.



# IEC 60352-5

Edition 5.0 2020-07

# INTERNATIONAL STANDARD

Solderless connections – Part 5: Press-in connections – General requirements, test methods and practical guidance

INTERNATIONAL ELECTROTECHNICAL COMMISSION

ICS 31.220.10

ISBN 978-2-8322-8476-6

Warning! Make sure that you obtained this publication from an authorized distributor.

# CONTENTS

FC	DREWO	RD	4
IN	TRODU	CTION	6
1	Scop	e	7
2	Norm	ative references	7
3	Term	s and definitions	8
4	Reau	irements	10
	4.1	General	10
	4.2	Tools	10
	4.2.1	General	10
	4.2.2	Tools evaluation	10
	4.3	Press-in terminations	10
	4.3.1	Materials	10
	4.3.2	Dimensions of the press-in zone	10
	4.3.3	Surface finishes	10
	4.4	Test boards	11
	4.4.1	General	11
	4.4.2	Materials	11
	4.4.3	Thickness of test boards	11
	4.4.4	Hole	11
	4.4.5	Plated-through hole	12
	4.5	Press-in connections	13
	4.6	Manufacturer's specification	14
5	Tests	;	15
	5.1	General remarks	15
	5.1.1	General	15
	5.1.2	Standard conditions for testing	15
	5.1.3	Mounting of specimens	15
	5.2	Test and measuring methods	16
	5.2.1	General examination	16
	5.2.2	Mechanical tests	16
	5.2.3	Contact resistance measurements	19
	5.2.4	Climatic tests	20
	5.3	Test schedules	21
	5.3.1	General	21
	5.3.2	Qualification test schedule	21
	5.3.3	Flow chart	23
	5.3.4	Application test schedule	24
	5.4	Test report	25
	5.4.1	Qualification test report	25
	5.4.2	Application test report	26
Ar	nnex A (	informative) Practical guidance	27
	A.1	General	27
	A.2	Current-carrying capacity	27
	A.3	Tool information	27
	A.3.1	Termination insertion tool	27
	A.3.2	Support block	27

- 3 -

A.3.3	Termination removal tool	
A.4 Inf	ormation to press-in termination and press-in connections	
A.4.1	General	
A.4.2	Design features	
A.4.3	Materials and surface finishes	29
A.4.4	Press-in terminations with connector contact elements	29
A.5 Pri	nted board information	29
A.5.1	General	29
A.5.2	Plated-through hole	
A.5.3	Dimensioning of the hole	
A.5.4	Manufacturing of the hole, example with drilling for FR4	31
A.5.5	Manufacturing of the hole with materials other than FR4	31
A.6 Pre	ess-in connection information	
A.6.1	General	
A.6.2	Press-in connection	
A.6.3	Repair of press-in connections	
A.6.4	Combination of press-in connections and soldered connections	
A.6.5	Bimetallic electrolytic corrosion effects	
Bibliography.		
Figure 1 – Gu	uide for hole ranges in a test board	12
Figure 2 – Pla	ated-through hole	13
Figure 3 – Lo copper thickn	cation and example of the transversal microsection for measuring the	13
Figure 4 – Te	est arrangement – push-out force	17
Figure 5 – Transverse section of a press-in connection		
Figure 6 – Lo	ingitudinal section of a press-in connection	19
Figure 7 To	est arrangement for contact resistance	
		20
Figure A.1 –	Conceptual composition of a four-layer printed circuit board	
Figure A.2 –	Example of a termination removal tool	33
Table 1 – Pla	ted-through hole requirements for test printed boards	12
Table 2 – Vib	ration, preferred test severities	18
Table 3 – Qualification test schedule – Test group AP		
Table 4 $-$ Qualification test schedule $-$ Test group RP 22		
	alification test schedule – Test group CP	22 ງາ
	almoation test schedule - Test group CF	
i abie 6 – Api	plication test schedule – Lest group DP	25
Table A.1 – E	Example for dimensioning the printed circuit board hole	31

- 4 -

## INTERNATIONAL ELECTROTECHNICAL COMMISSION

## SOLDERLESS CONNECTIONS -

# Part 5: Press-in connections – General requirements, test methods and practical guidance

## FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.
- 5) IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any services carried out by independent certification bodies.
- 6) All users should ensure that they have the latest edition of this publication.
- 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
- 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

International Standard IEC 60352-5 has been prepared by subcommittee 48B: Electrical connectors, of IEC technical committee 48: Electrical connectors and mechanical structures for electrical and electronic equipment.

This fifth edition cancels and replaces the fourth edition published in 2012. This edition constitutes a technical revision.

This edition includes the following significant changes with respect to the previous edition:

- a) revising the scope by removing the wording "... telecommunication equipment and in electronic devices employing similar techniques" and replacing it by "... electrical and electronic equipment and components" in the first paragraph;
- b) adding terms and definitions for 'board', 'hole' and 'metal board' to recognize that press-in terminations are being used in many non-printed board materials;

IEC 60352-5:2020 © IEC 2020

- 5 -

- c) editorial changes to clarify the difference between the two test schedules for qualification and application;
- d) modification of upper limit of copper thickness of the plated-through-hole to reflect actual market trends and manufacturing practices;
- e) removal of bending test, as this test is very specific for applications of press-in technology no longer common;
- f) adding graphs to document the press-in and push-out force, since this is common testing practice and provides further insight into mechanical performance of the contact zone;
- g) reducing the number of test specimens required, since in previous testing scheme a lot of test samples were discarded;
- h) new wording in 4.5 for cracked and bent terminations;
- i) added Figure 7b to show V and A connection locations when the press-in termination does not protrude through the bottom side of the board.

The text of this International Standard is based on the following documents:

FDIS	Report on voting	
48B/2810/FDIS	48B/2822/RVD	

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 60352 series, published under the general title *Solderless connections*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

- 6 -

IEC 60352-5:2020 © IEC 2020

## INTRODUCTION

This part of IEC 60352 includes requirements and relevant tests (normative) as well as a practical guidance in Annex A (informative) for press-in connections.

Two test schedules are provided.

a) The qualification test schedule applies to individual press-in connections to demonstrate the suitability of the press-in zone.

These press-in connections are tested to the specification provided by the manufacturer of the press-in termination (see 4.6) taking into account the requirements of Clause 4.

The qualification is independent of the application of the press-in zone in a component.

b) The application test schedule applies to press-in connections which are part of a component and are already qualified to the qualification test schedule.

Test sequences focus on the performance of the press-in connection which is affected by the implementation in a component.

The requirements and tests apply to all elements involved in the manufacturing of a press-in connection:

- the press-in termination, which may be part of a component (e.g. a multi-pole connector);
- the board, printed board or MID (moulded interconnect device) (plated-through holes dimensions) for which the termination is suitable;
- the tool(s) required to produce the press-in connection.

As the manufacturer of the press-in termination has to provide the main part of the information needed for qualification, the word "manufacturer" is used throughout this document for simplicity to indicate the manufacturer of the press-in termination. The manufacturers of the other items playing a role in the qualification of press-in connections are specified, if needed, as the board manufacturer or the tool(s) manufacturer.

The practical guidance in Annex A (informative) serves as a guide for the workmanship required in 4.1. Attention is drawn to the fact that some industries (e.g. automotive, aircraft and aerospace, nuclear, military) may have specific workmanship standards and/or quality requirements, which are outside the scope of this document.

IEC Guide 109 advocates the need to minimize the impact of a product on the natural environment throughout the product life cycle.

IEC 60352-5:2020 © IEC 2020

# SOLDERLESS CONNECTIONS -

# Part 5: Press-in connections – General requirements, test methods and practical guidance

## 1 Scope

This part of IEC 60352 is applicable to solderless press-in connections for use in electrical and electronic equipment and components.

The press-in connection consists of a termination having a suitable press-in zone which is inserted into a hole of a board.

Information on materials and data from industrial experience is included in addition to the test procedures to provide electrically stable connections under specified environmental conditions.

The object of this document is to determine the suitability of press-in connections under mechanical, electrical and atmospheric conditions as specified by the manufacturer of the press-in termination and to provide a means of comparing test results when the tools used to make the connections are of different designs or manufacture.

## 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-1, Environmental testing – Part 1: General and guidance

IEC 60512-1, Connectors for electrical and electronic equipment – Tests and measurements – *Part 1: Generic specification* 

IEC 60512-1-1, Connectors for electronic equipment – Tests and measurements – Part 1-1: General examination – Test 1a: Visual examination

IEC 60512-1-2, Connectors for electronic equipment – Tests and measurements – Part 1-2: General examination – Test 1b: Examination of dimension and mass

IEC 60512-2-1, Connectors for electronic equipment – Tests and measurements – Part 2-1: Electrical continuity and contact resistance tests – Test 2a: Contact resistance – Millivolt level method

IEC 60512-2-5, Connectors for electronic equipment – Tests and measurements – Part 2-5: Electrical continuity and contact resistance tests – Test 2e: Contact disturbance

IEC 60512-6-4, Connectors for electronic equipment – Tests and measurements – Part 6-4: Dynamic stress tests – Test 6d: Vibration (sinusoidal)

IEC 60512-11-1, Connectors for electrical and electronic equipment – Tests and measurements – Part 11-1: Climatic tests – Test 11a – Climatic sequence



This is a free preview. Purchase the entire publication at the link below:

**Product Page** 

S Looking for additional Standards? Visit Intertek Inform Infostore

> Learn about LexConnect, All Jurisdictions, Standards referenced in Australian legislation